SMART Modular Technologies’ Gen-Z scalable computing interconnect protocol provides a simplified interface based on memory semantics and is designed to handle advance workloads, enabling data centric computing with scalable memory pools and resources for real-time analytics and in memory applications. The Gen-Z standard was developed to enable new solution architectures for delivering high levels of performance (high-bandwidth, low-latency), software efficiency, power optimizations, and industry agility.

Why the ZMM?
New type of design challenges
• The increase in number of CPU cores has not been matched by an increase in memory bandwidth leading to memory bandwidth starved CPU cores. By being able to support more memory interfaces and memory modules Gen-Z serial attached ZMM memory increases memory bandwidth per core increasing system performance.
• Gen-Z ZMM memory provides load-store direct addressing to memory by applications eliminating operating system and device driver overhead. CPU cores spend more time executing end applications.

Workloads are changing
• Latest HPC models and AI/ML algorithms require large pool of memory to store intermediate data sets. These data sets require concurrent access from multiple compute nodes. Thus such workloads need large pool of shared memory, independent of any compute node.

New Generation of Hardware
• As network speeds are increasing, the latency difference between local attached memory and remotely accessible memory is decreasing. Addition of specialized hardware accelerators running cache coherent protocols is reducing the latency gap.

Features & Benefits
• Multiple access semantics support (Byte and Block addressable DRAM access, In-band configuration, Access Key/Region Key memory isolation opcodes)
• Gen-Z Phy support (16 total links - 4x, 4-lane links, 802.3 25Gbps), with 4 requestor and 4 responder configuration
• Write command collision detection and ordering logic with support for 9 to 11 cycles of CAS write latency at 2400 MTS
• Media scrubbing (background ECC detection and correction)
• Gen-Z Lane Reduction support

Product Description
• Gen-Z Form Factor 4C-SFF-TA-1008/9 (EDSFF 3-inch form factor compliant)
• Available in 64/128/256GB capacities of dual rank DDR4 memory with ECC.
• Available in user-programmable FPGA variant to allow adding custom logic for differentiation, or add hardware engines in FPGA, which can offload specific functions to memory module, right next to where data resides.

Applications
• In-Memory Analytics
• Similarity Search
• Large-scale Graph Inference
• Financial Modeling
Transforms Performance

- In-memory analytics
- Similarity search
- Large-scale graph inference
- Financial models

15x faster
20x faster
100x faster
8,000x faster

Composable Memory Concept

Gen-Z Enabled System/Chassis

- DRAM/SCM can be placed anywhere in a rack!
- DRAM/SCM can be placed wherever storage is placed!
- Utilize existing or new form factors
- Relieves electrical/thermal constraints

Gen-Z Enabled Rack-scale

- Single-wide Compute (CPU, GPU, FPGA, etc.)
- Double-wide Compute (CPU, GPU, FPGA, etc.)
- Single-wide DRAM Fabric: Attached Memory
- Double-wide DRAM Fabric: Attached Memory
- Single-wide SCM Fabric: Attached Memory
- Double-wide SCM Fabric: Attached Memory

Ordering Information

<table>
<thead>
<tr>
<th>Gen-Z, ZMM</th>
<th>SMART Part Number</th>
<th>Density</th>
<th>Form Factor</th>
<th>Device Config</th>
</tr>
</thead>
<tbody>
<tr>
<td>SMART</td>
<td>STZAB25G7B4Q36SM</td>
<td>256GB</td>
<td>Gen-Z 3.0&quot; Form Factor 4C-SFF-TA-1008/9 (104.90 x 76.00 x 16.80mm)</td>
<td>x64 + 8 bit ECC) dual rank DDR4</td>
</tr>
<tr>
<td>SMART</td>
<td>STZAB12G7B4Q18SM</td>
<td>128GB</td>
<td></td>
<td></td>
</tr>
<tr>
<td>SMART</td>
<td>STZAB06G7B4Q36SM</td>
<td>64GB</td>
<td></td>
<td></td>
</tr>
<tr>
<td>SMART</td>
<td>STFAB06G7B4Q36SM</td>
<td>64GB</td>
<td>User Programmable 3.0&quot; Form Factor 4C-SFF-TA-1008/9 with FPGA (104.90 x 76.00 x 16.80mm)</td>
<td></td>
</tr>
</tbody>
</table>

Contact information

Corporate Headquarters/North America: T: (+1) 800-956-7627 • T: (+1) 510-623-1231 • F: (+1) 510-623-1434 • E: info@smartm.com
Customer Service: T: (+1) 510-623-1231 • E: customers@smartm.com
Latin America: T: (+55) 11 4417-7200 • E: sales.br@smartm.com
EMEA: T: (+44) 0 7826-064-745 • E: sales.euro@smartm.com
Asia/Pacific: T: (+65) 6678-7670 • E: sales.asia@smartm.com
For more information, please visit: www.smartm.com

©2020. All rights reserved. The stylized “S” and “SMART” as well as “SMART Modular Technologies” are trademarks of SMART Modular Technologies. All other trademarks and registered trademarks are the property of their respective companies.